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(71)Applicant:

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Priority number: 09 24312

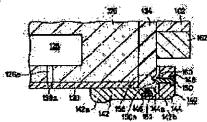
Priority date: 23.01.1997

Priority country: JP

## (54) PLASMA PROCESSING DEVICE

(57)Abstract:

PROBLEM TO BE SOLVED: To provide a shield ring by which an interval of cleaning or exchanging can be lengthened and further a maintenance cost can be reduced. SOLUTION: The shield ring 140 is constituted of an inside member 142 and an outside member 144 and the inside member 142 is arranged at a position where deposit is easily stuck thereto and sputtering is easily executed. Further, the inside member 142 is formed of an insulating resin such as a polyimide series resin which is more hardly stack with deposits than the outside member 144 and is hardly sputtered and has heat resistance and sputtering resistance.



LEGAL STATUS

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06.08.2001

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[Kind of final disposal of application other than the examiner's decision of rejection or application converted registration]

[Date of final disposal for application]

[Patent number] [Date of registration] 3424903

02.05.2003

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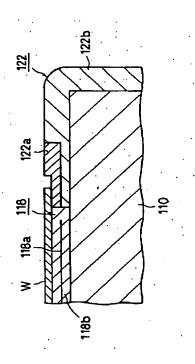
1. This document has been translated by computer. So the translation may not reflect the original precisely.

2.\*\*\* shows the word which can not be translated.

3.In the drawings, any words are not translated.

## DRAWINGS

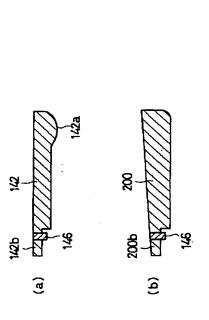
[Drawing 2]



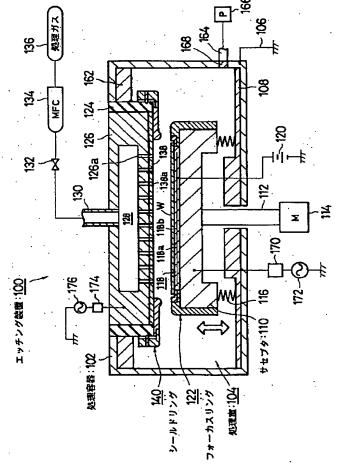
[Drawing 5]

[Drawing 3]

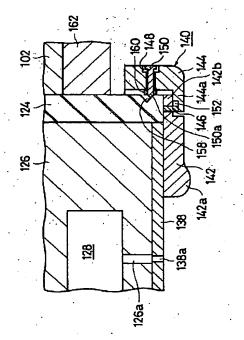
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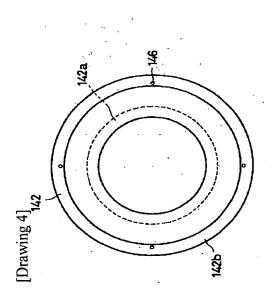


[Drawing 1]



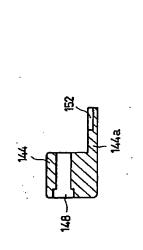
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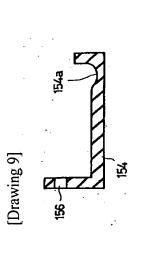


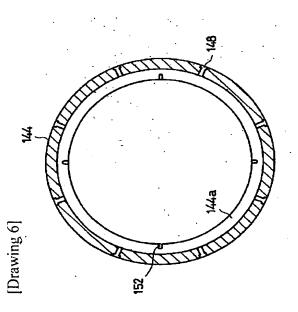


[Drawing 7]

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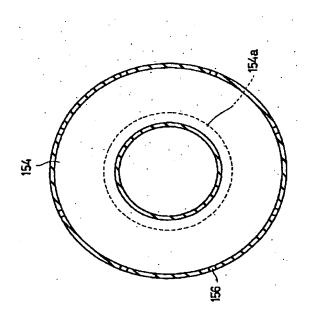


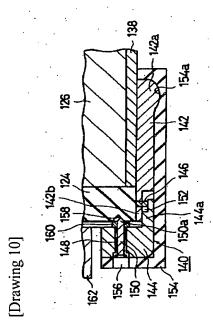




[Drawing 8]

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[Translation done.]

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